

REV	ECN NO	CONTENT	DATE	ENGINEER
A0		INITIAL RELEASE	/	SGF

Notes:

1. Material:

1.1 Housing: thermoplastic high temp.
UL94V-0; Color: Natural.

1.2 Actuator: thermoplastic high temp.
UL94V-0; Color: black.

1.3 Terminal: copper alloy.

1.4 Hold down: copper alloy.

2. Finish:

2.1 Terminal:

50u" Min. Nickel underplated overall.

I:Gold flash on Contact area and solder area

K:Gold 3u" on Contact area and solder area

M:Gold 5u" on Contact area and solder area

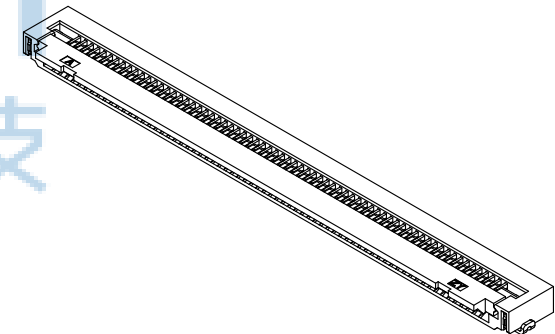
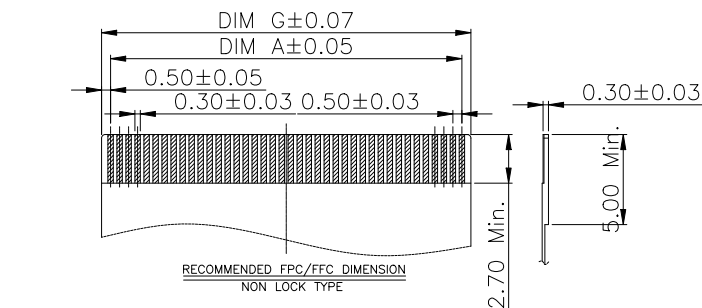
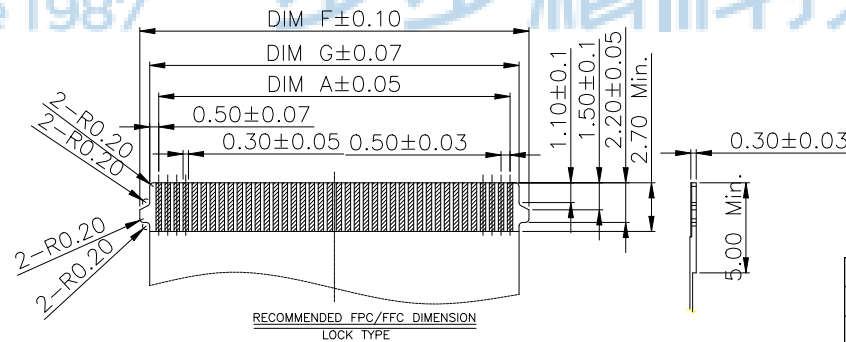
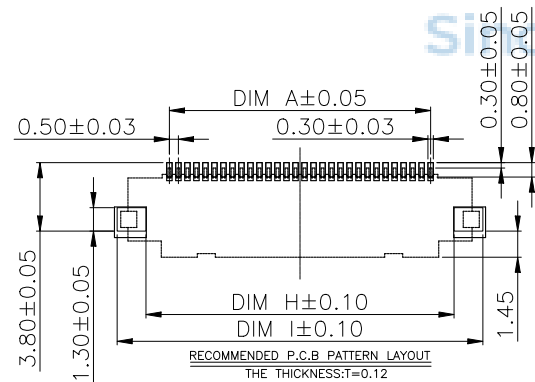
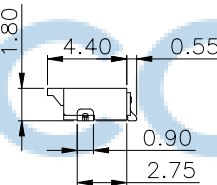
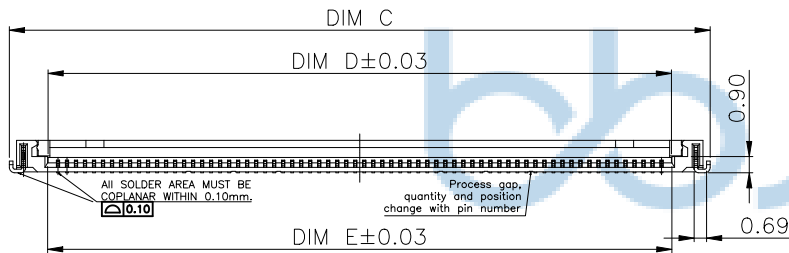
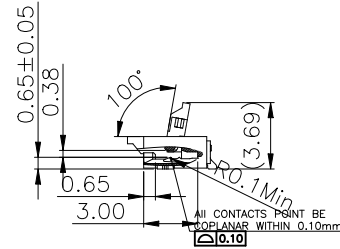
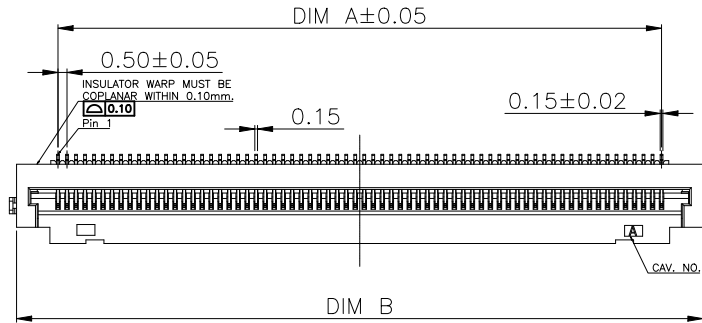
R:Gold 10u" on Contact area and solder area

2.2 Fitting Nail:

50u" Min. Nickel underplated overall.

80~150u" Min. Matte Tin plated.

3. Product must comply HF RoHS specification.



CKT	DIM A	DIM B	DIM C	DIM D	DIM E	DIM F	DIM G	DIM H	DIM I
21	10.00	14.60	15.40	11.10	11.15	12.10	11.00	12.60	15.80
30	14.50	19.10	19.90	15.60	15.65	16.60	15.50	17.10	20.30
40	19.50	24.10	24.90	20.60	20.65	21.60	20.50	22.10	25.30
50	24.50	29.10	29.90	25.60	25.65	26.60	25.50	27.10	30.30
60	29.50	34.10	34.90	30.60	30.65	31.60	30.50	32.10	35.30
80	39.50	44.10	44.90	40.60	40.65	41.60	40.50	42.10	45.30

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PDWG NO: 0407-1

深圳市步步精科技有限公司

NAME: FPC 0.5-80P 翻盖下接 H=1.8 编带	
PJ NO: 130-224-800001-W3G	SIZE:A4 DRW NO:
FINISH:SEE NOTES	MAT'L:SEE NOTES
SCALE:N/A	REV:A0
UNIT:mm	PAGE:1/2

APPD JM_Zheng

CHKD LYX

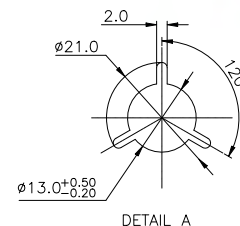
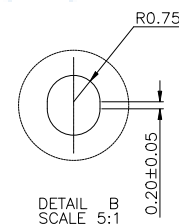
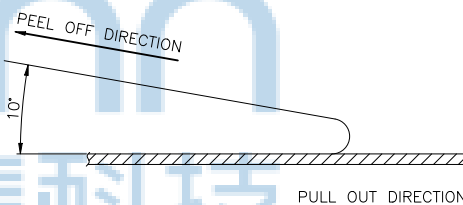
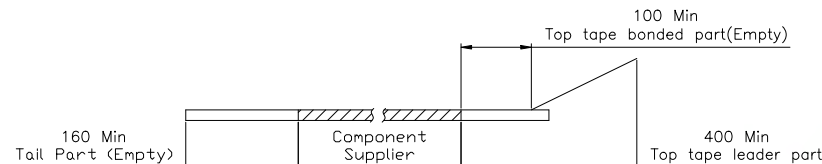
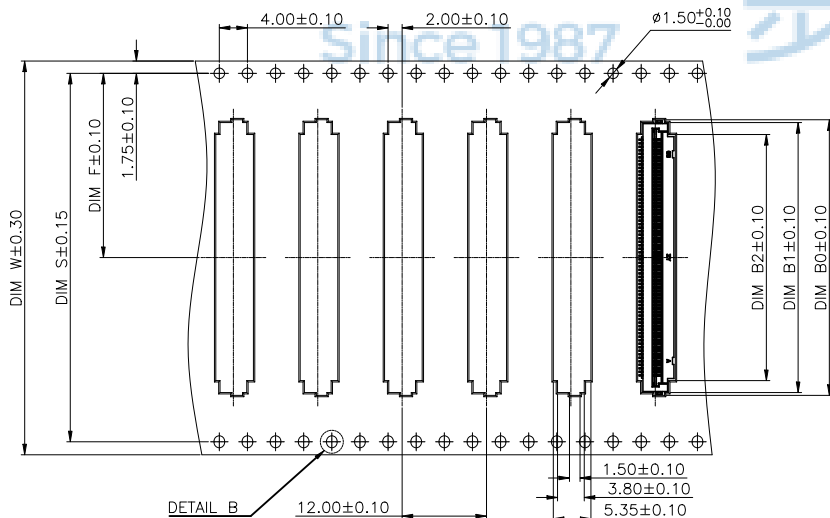
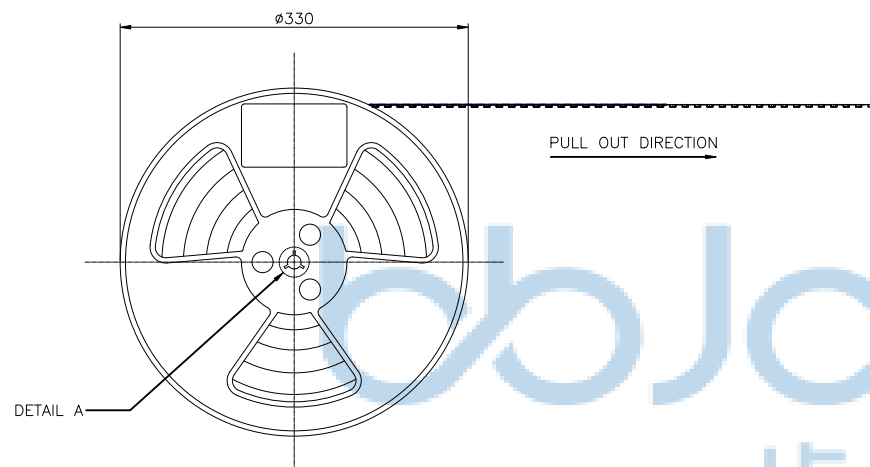
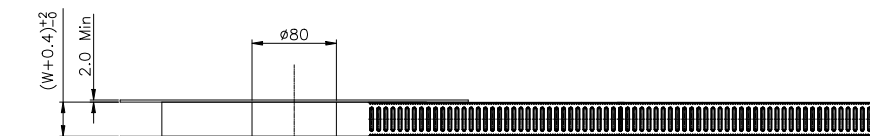
DR

SGF

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NOTES:

1. 10 SPROCKET HOLE PITCH CUMULATIVE TOLERANCE. $\pm 0.20\text{mm}$
2. CARRIER CAMBER NOT TO EXCEED 1mm IN 250mm.
3. ALL DIMENSIONS MEET EIA-481-C REQUIREMENTS.
4. MATERIAL: WHITE ANTI-STATIC PET.
5. THICKNESS: $0.30 \pm 0.05 \text{ mm}$.
6. PACKING LENGTH PER 13" REEL : 24.60METERS.
7. COMPONENT LOAD PER 13" REEL : 2000PCS.
8. PEELING OFF FORCE OF TOP TAPE 0.1N~0.7N(10.2gf~71.4gf).



CKTS	DIM B0	DIM B1	DIM B2	DIM W	DIM S	DIM F
21	15.70	14.90	11.50	32.00	28.40	14.20
30	20.20	19.40	16.00			
40	25.20	24.40	21.00	44.00	44.40	20.20
50	30.20	29.40	26.00			
60	35.20	34.40	31.00	56.00	52.40	26.20
80	45.20	44.40	41.00			

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.X: ± 0.38 X': $\pm 3'$
.XX: ± 0.25 .X': $\pm 2'$
.XXX: ± 0.13 .XX': $\pm 1'$

APPD JM_Zheng
CHKD LYX

DR SGF

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